

## **Quarterly Reliability Monitoring Results**

## Quarters: Q1/2022 to Q4/2023

Based on structural similarity

Supplier Nexperia B.V. Name of Laboratory Assembly reliability labs Based on AEC-Q101 Test		User Part Number BC847W-Q Part Description											
									Nexperia DHAM Small Signal Bipolar Transistor				
									SMD package				
		Test Conditions	Duration	# Lots	# Quantity	# Rejects							
			TEST										
			Pre- and Post-Stress										
# E1	Electrical Test	Tamb = 25 °C	N/A	see below	all parts	see below							
		JESD22-A113											
		Bake Tamb = 125 °C	24 hours										
	PC	Soak Tamb = 85 °C, RH = 85%	168 hours										
# A1	Preconditioning	Reflow soldering	3 cycles	1674	70490	0							
		MIL-STD-750-1											
	HTRB	M1039 Method A											
	3 .	Tj = Tjmax, Vr = 100% of max. datasheet											
# B1	Bias	reverse voltage	1000 hours	415	18680	0							
	<b>T0</b>	JECD22 A104											
4 4 4	TC Temperature Cycling	JESD22-A104 -65 °C to Timax, not to exceed 150°C	1000	242	15260	0							
# A4	remperature cycling	-03 C to filliax, flot to exceed 130 C	1000 cycles	343	15360	0							
	UHAST	JESD22-A118											
# A3 <b>or</b>	Unbiased HAST	Tamb = 130 °C, RH = 85 %	— 96 hours	362	15920	0							
		JESD22-A102											
	AC	Tamb = 121 °C, RH = 100 %											
# A3 alt	Autoclave	Pressure = 205 kPa (29.7 psia)											
715 010		· · · ·											
	H3TRB	JESD22-A101											
	High Humidity High	Tamb = 85 °C, RH = 85%, VR = 80 % of											
# A2 alt		rated reverse voltage <sup>[1]</sup>	1000 hours	343	15360	0							
		MIL-STD-750 Method 1037											
	IOL	ton = toff, devices powered to insure $\Delta Tj$ =											
# A5	Intermittent Operating Life	100 °C for 15000 cycles	1000 hours	343	15360	0							
	RSH	JESD22-A111											
# C8	Resistance to Solder Heat	260 °C ± 5 °C	10 s	283	8490	0							
	SD												
# C10	Solderability	J-STD-002		214	6420	0							

<sup>[1]</sup> The maximum applied voltage is limited by test chamber set up and does not exceed 115V.

## **Calculation of FIT and MTTF**

Test considered for FIT calculation: High Temperature Reverse Bias (HTRB, Test #B1) Confidence level 60%, derated to 55 °C, activation energy 0.7 eV, test time 168 to 1000 hours

Wafer Fab	Technology	Quantity	Rejects	Failure Rate (FIT)	MTTF (hrs)
Nexperia	Small Signal Bipolar				
DHAM	Transistor	18680	0	0,23	4,40E+09

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